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FSA2000 Auto-Selecting HS-USB Switch with Cap-Free Headphone **Audio Amplifier**

Features

| olifier √ _{BUS}) |
|-------------------------------|
| 1> |
| BUS) |
| YES |
| ed & oliant |
| s AB |
| 32Ω) |
| 0dB |
| 0.1% |
| 90dB |
| 95dB |
| 4.3V |
| 3mA |
| 6μΑ |
| .60 x |
| pitch |
| UMX |
| |

Description

The FSA2000 is a low-cost integrated HS-USB and audio switch that incorporates an audio headphone amplifier. This solution eliminates many of the discrete parts currently used in stereo headset applications. It provides stereo headphone drivers designed to operate with a ground-centered output signal. This allows for the removal of large and expensive DC blocking capacitors. The headphone drivers are capable of driving up to 40mW_{RMS} per channel.

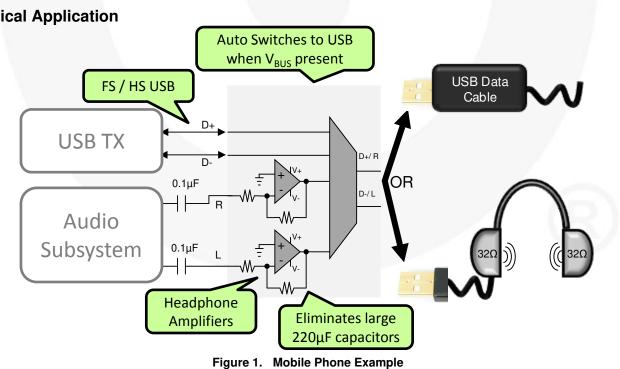
Related Resources

- FSA2000 Demonstration Board
- FSA2000 Evaluation Board .
- FDB323 FSA2000 Demonstration Board User Guide
- FEB322 FSA2000 Evaluation Board User Guide
- AN-8032 Demonstration Board Quick-Start Guide
- AN-8031 Utilizing the FSA2000 MUTE Function to Reduce Audio "Click" and "Pop"
- For samples, questions, or board requests; please contact: Analog.Switch@fairchildsemi.com.

Applications

- MP3 Portable Media Players
- Cellular Phones, Smartphones

Typical Application

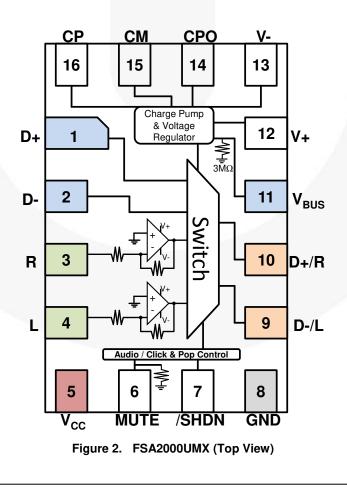


March 2013

Pin Descriptions

| Pin # | Name | Туре | Description |
|-------|------------------|--------------|---|
| 1 | D+ | I/O | USB D+ port from processor or transceiver |
| 2 | D- | I/O | USB D- port from processor or transceiver |
| 3 | R | Input | Right audio channel input |
| 4 | L | Input | Left audio channel input |
| 5 | V _{CC} | Audio Supply | Supply voltage for audio amplifiers, charge pump, and audio control; not required for USB path |
| 6 | MUTE | Input | Control pin intended to be used temporarily to quiet transients on the audio path upon transition of /SHDN. Ground if not being used. |
| 7 | /SHDN | Input | Shutdown Enable (Requires V _{CC} only) |
| 8 | GND | GND | IC ground |
| 9 | D-/L | I/O | Common USB/Audio Port; USB D- data to connector or left audio channel output |
| 10 | D+/R | I/O | Common USB/Audio Port; USB D+ data to connector or right audio channel output |
| 11 | V _{BUS} | Input/Supply | USB input select pin and USB supply |
| 12 | V+ | Node | Node for filtering internal positive amplifier rail; suggest 1µF to GND |
| 13 | V- | Input | Negative amplifier rail input; suggest 1µF to GND. Requires connection to CPO. |
| 14 | CPO | Output | Charge pump output used to drive V-, suggest 2.2 μ F to GND for filtering. |
| 15 | CM | I/O | Charge pump negative flying capacitor pin; connect to CP via storage capacitor, typically 1μ F. |
| 16 | CP | I/O | Charge pump positive flying capacitor pin; connect to CM via storage capacitor ,typically 1μ F. |

Pin Configuration

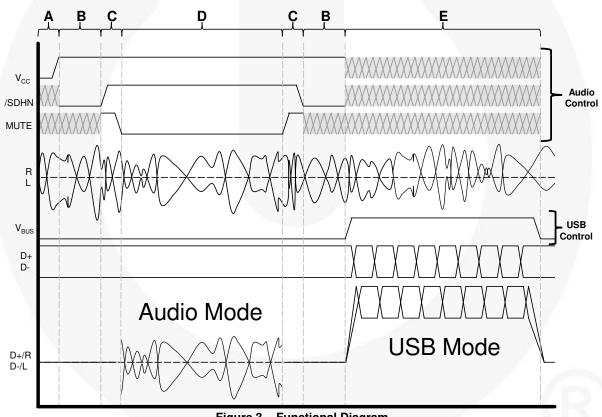


Functional Diagram

| Functional Mode | Power Down | Audio Power Down | Transient Suppression | Audio Mode | USB Mode |
|-----------------------|------------------|------------------|--------------------------|------------|------------------|
| V _{BUS} | LOW | LOW | LOW | LOW | HIGH |
| V _{cc} | LOW | HIGH | HIGH | HIGH | X ⁽¹⁾ |
| /SHDN | X ⁽¹⁾ | LOW | HIGH | HIGH | X ⁽¹⁾ |
| MUTE | X ⁽¹⁾ | X ⁽¹⁾ | HIGH | LOW | X ⁽¹⁾ |
| Charge Pump | OFF | OFF | ON | ON | OFF |
| R/L Amplifiers | OFF | OFF | OFF | ON | OFF |
| D+/R, D-/L | HI-Z | HI-Z | D+/R, D-/L=0V | R/L | D+/D- |
| Figure 3 Label | А | В | С | D | E |

Notes:

The (X) indicates "Don't Care" state. 1.



- Figure 3. Functional Diagram
- Audio Power Down -An active-LOW shutdown pin (/SHDN) allows the amplifiers to be placed in low-power (or shutdown) mode to conserve battery power. While the FSA2000 is in shutdown mode, USB data transfers are allowed whenever a USB cable is connected to a host (V_{BUS} is HIGH). The audio amplifiers are enabled and connected to the common port when /SHDN is HIGH and V_{BUS} is LOW.
- Transient Suppression The FSA2000 audio amplifier has a soft turn-on feature that suppresses click and pop on the audio path when the path is selected. In addition to the soft turn-on feature of the amplifier, the MUTE pin mutes the audio path when asserted HIGH. The mute functionality also has an internal pull-down that disables mute if the MUTE pin is floated. The MUTE pin allows control of the mute functionality by the application. Please refer to application note AN-8031, describing the recommended timing and control of MUTE for optimal performance.

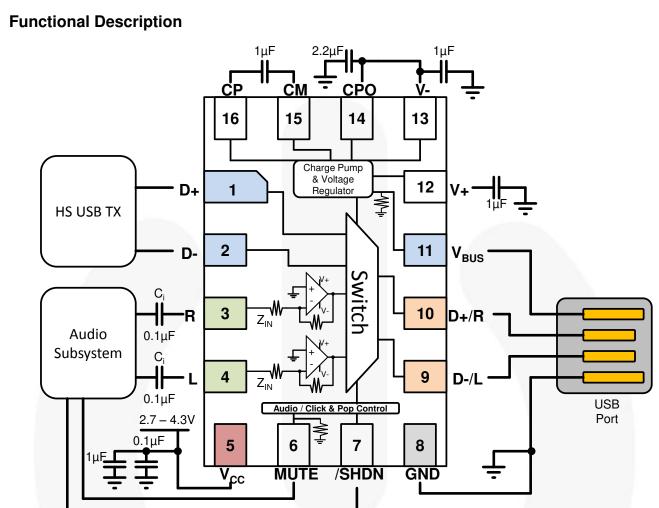


Figure 4. Micro-USB Application

Application Guidelines

- Device Placement Minimize to USB port & USB TX.
- **PIN 1, 2, 9, 10** Minimize and match trace lengths for USB compliance.
- PIN 3, 4 Suggest 0.1µFcapacitor as close to the device as possible for DC-blocking and setting low-frequency response of audio amplifier. The input capacitors combine with the input impedance of the amplifiers to form a high-pass filter. Equation 1 can be used to calculate the -3dB cut-off frequency of the high-pass filter for the given input capacitor value and the FSA2000 input impedance.

$$f_{-3dB} = \frac{1}{2\pi \cdot Z_{IN}C_{i}}$$
(1)

$$17.7Hz = \frac{1}{2\pi (90k\Omega)(0.1\mu F)}$$
(2)

 It is desirable to be below the 20Hz audio range. Users have flexibility to adjust capacitor for audio performance in the system design. Equation 2 shows the cut-off frequency of the recommended guidelines.

- **PIN 5** Use standard decoupling devices, 0.1µF & 1µF capacitors; as close to the device as possible.
- PIN 8 Minimize ground trace length between headphone connector and device; minimize ground path resistance.
- PIN 12 Suggested 0.1µFcapacitor to GND for filtering; as close to the device as possible.
- PIN13, 14 Use low-ESR (equivalent series resistance) ceramic capacitors for lowest charge pump impedance, which provides maximum output power of the audio amplifiers. Recommended to place the components as close as possible to the device.
- PIN15, 16 The charge pump has been optimized for low-ESR ceramic capacitors for the flying capacitor between CP and CM, along with the output capacitors on V+, CPO, and V-. Optimized values for these capacitors are in Figure 4.

Detailed Description

USB Compliance

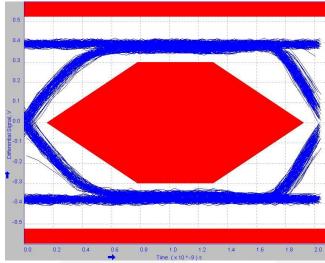


Figure 5. High-Speed USB 2.0 Eye Compliance (5.5V)

Transient Suppression

A common issue with headphone amplifiers is audible noises through the headset when the amplifier is powering up or down. Sharp transients often occur on the audio outputs during this transition that cause audible "click and pop." The FSA2000 prevents these transients during power-up by muting the outputs until the internal charge pumps are stable. This ensures that any transients caused by the charge pump are not propagated to the outputs. In cases where the application needs a longer startup time for mute, the FSA2000 has a MUTE pin that allows application control over the behavior of the amplifier during startup and power down. The MUTE pin forces the audio outputs into a known and controlled state so that any transients of the amplifier are not propagated to the headphones as clicks and pops. Figure 6 shows the correct timing of the MUTE pin in relation to the /SHDN pin for optimal click and pop performance.

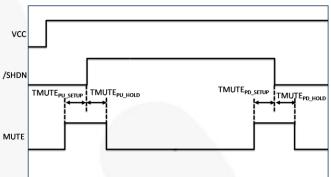


Figure 6. Power-Up and Power-Down Timing

Table 1. Recommended MUTE Timing

| Parameter | Description | Suggested Timing |
|---------------------------|--|---------------------|
| TMUTE _{PU_SETUP} | MUTE setup time to /SHDN rising edge | <u>></u> 500ns |
| TMUTE _{PU_HOLD} | MUTE hold time to /SHDN rising edge | ~500ns |
| TMUTE _{PD_SETUP} | MUTE setup time to /SHDN falling edge | <u>></u> 500ns |
| TMUTE _{PD_HOLD} | MUTE hold time to /SHDN falling edge | ~500ns |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Para | meter | | Min. | Max. | Unit |
|----------------------|---|---|------------------|------------------------|-----------------------|------|
| N | Supply Voltage | Audio Mode | | -0.3 | +4.5 | V |
| V _{cc} | Supply Voltage | USB Mode | | -0.3 | +6.0 | v |
| V _{BUS} | Supply Voltage | | | -0.3 | +6.0 | V |
| V _{CNTRL} | Control Pin Voltage - /SHDN, MUTE | | | -0.3 | +6.0 | V |
| V _{SWUSB} | USB I/O | | | $V_{\text{BUS}} - 6.0$ | V_{BUS} + 0.3 | V |
| V _{SWAUDIO} | Audio I/O | | | $V_{CC}-6.0$ | V _{CC} + 0.3 | V |
| I _{SW} | Switch I/O Current (Continuous) | | | | 30 | mA |
| I _{PEAK} | Peak Switch I/O Current (Pulsed, 1ms De | uration, <10% Duty Cycle) | | | 50 | mA |
| TJ | Junction Temperature | | | | +150 | °C |
| T _{STG} | Storage Temperature Range | | | -65 | +150 | °C |
| TL | Lead Temperature (Soldering, 10 second | ds) | | | +240 | °C |
| | IEC 61000-4-2 System USB Connecto | or pins (D+/R, D-/L, V _{BUS}) | Air Gap | 15 | | |
| | | | D+/R, D-/L | 4 | | |
| ESD | JEDEC JESD22-A114, Human Body Mod | del | All Other Pins | 2 | | kV |
| | | | V _{BUS} | 1 | | |
| | JEDEC JESD22-C101, Charged Device | Model | All Pins | 2 | | |

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding these ratings or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|----------------------|--|------|------|------------------|------------------|
| V _{BUS} | USB Supply Voltage | 4.0 | 5.0 | 5.5 | V |
| Vcc | Supply Voltage | 2.7 | 3.3 | 4.5 | V |
| V _{CNTRL} | Control Voltage - /SHDN, MUTE | 0 | | V _{cc} | V |
| V _{SWUSB} | D+/L, D-/R, D+, D- Input Range | 0 | | V _{BUS} | V |
| V _{SWAUDIO} | L,R Audio Input Range | -2.5 | | V _{cc} | V |
| V _{SWING} | L,R Audio Input Amplitude | | | 5 | V _{P-P} |
| T _A | Temperature Range | -40 | +25 | +85 | °C |
| Z_{LOAD} | Headset Load Impedance | 16 | 32 | | Ω |
| Θ_{JA} | Package Thermal Resistance, JEDEC Standard Multi-Layer Boards, Still Air | | 40 | | °C/W |

DC Electrical Characteristics

 $T_A = 25^{\circ}C$, $V_{CC} = 3.0V$, audio inputs at -6dBV and AC coupled with 0.1μ F, audio outputs DC coupled into 32Ω loads referenced to 1kHz, unless otherwise noted.

| Symbol | Deveryoter | N 00 | Qanditiana | Τ _Α = | - 40°C to - | +85°C | Unit |
|------------------------|--|--|---|------------------|-------------|-------|------|
| Symbol | Parameter | Parameter V _{CC} (V) Conditions | | Min. | Тур. | Max. | Unit |
| Common P | ins | | | | | | · |
| V _{IH} | /SHDN, MUTE, Control Input Voltage HIGH | 2.7 to 4.5 | | 1.65 | | | v |
| VIL | Control Input Voltage LOW | 2.7 to 4.5 | | | | 0.5 | |
| i | /SHDN, MUTE, Input HIGH | 4.5 | $V_{CNTRL} = 3.6V$ | -1 | | 10 | μA |
| I _{IN} | Current | 4.5 | $V_{\text{CNTRL}} = 0V$ | -1 | | 1 | μΑ |
| I _{OFF} | Power Off Leakage Current | $V_{\text{CC}} = V_{\text{BUS}} = 0$ | Common Port (D+/R, D-/L) $V_{SW} = 0V, 5.5V$ | | | 10 | μA |
| I _{NO(0FF)} | Off-Leakage Current of Port D+, D- | 3.6 | $\begin{array}{l} D+/R, D-/L = 0.3V, \\ V_{CC} - 0.3V, D+, D- = 0.3V, \\ V_{CC} - 0.3V \ or \ Floating, \\ /SHDN=0V, \ V_{BUS}=0v, \\ MUTE=0V, \ R/L=0V \end{array}$ | -50 | 1 | 50 | nA |
| I _{NC(0N)} | On-Leakage Current of Port D+/R or D-/L | 3.6 | $\begin{array}{l} D+/R, D-/L=0.3V, V_{CC}-0.3V\\ D+, D-= Floating\\ V_{BUS}{=}5.5V, /SHDN{=}0V,\\ MUTE{=}0V, R/L{=}0V \end{array}$ | -50 | 1 | 50 | nA |
| R_{PD} | V _{BUS} , MUTE, Internal Pull-Down Resistor | | | | 3.5 | | MΩ |
| USB Switch | n Path | | | | | | |
| | USB Analog Signal Range | | | 0 | | 3.6 | V |
| R _{ONUSB} | HS Switch On Resistance ⁽²⁾ | V _{BUS} =5 | $V_{D+/D^-} = 0V, 0.4V, I_{ON} = -8mA$ | | 4.0 | 6.5 | Ω |
| ΔR_{ONUSB} | HS Delta R _{ON} ^(2, 3) | V _{BUS} =5 | $V_{D+/D-} = 0V, I_{ON} = -8mA$ | | 0.4 | | Ω |
| Audio Amp | lifier Path | | | | | | |
| Z _{IN} | Audio Amp Input Impedance ⁽⁴⁾ | 3.0 to 4.5 | | | 90 | | kΩ |
| Power Sup | oly | | | | | | |
| I _{CC(Audio)} | Quiescent Supply Current (Audio Mode) | 4.5 | $\label{eq:IOUT} \begin{split} I_{\text{OUT}} &= 0, / \text{SHDN} = V_{\text{CC}}, \\ \text{MUTE} &= 0 \text{V}, \text{D} + / \text{D} \text{-} = 0 \text{V} \end{split}$ | | 3 | 5 | mA |
| I _{CC(/SHDN)} | Quiescent Supply Current (V_{cc}) in Shutdown Mode | 4.5 | I _{OUT} = 0, /SHDN = 0V, MUTE=0V, D+/D-=0V | | 1 | 5 | μΑ |
| I _{CC(USB)} | Quiescent Supply Current (USB Mode) | V _{BUS} =5.5 | I _{OUT} =0, MUTE=0V, /SHDN=V _{BUS} , L/R=0V | | 6 | 10 | μA |

Notes:

2. On resistance is determined by the voltage drop between the D+/D- and D+/R,D-/L pins at the indicated current through the switch.

 $\Delta R_{ON} = R_{ON_max} - R_{ON_min} \text{ measured at identical } V_{CC} \text{, temperature, and voltage.}$ Guaranteed by characterization, but not production tested. 3.

4.

AC Electrical Characteristics

 $T_A = 25^{\circ}C$, $V_{CC} = 3.0V$, audio inputs at -6dBV and AC coupled with 0.1μ F, audio outputs DC coupled into 32Ω loads referenced to 1kHz, unless otherwise noted.

| Symbol | Parameter | V _{cc} (V) | Conditions | T _A = | - 40°C to |) +85°C | Unit |
|-----------------------|---|---------------------|---|------------------|-----------|---------|-------------------|
| Symbol | Farameter | | | Min. | Тур. | Max. | Unit |
| Audio Amp | lifier Path | | | • | | | |
| tonaudio | Turn-On Time /SHDN to Output | 3.0 to 4.5 | $V_{D+/R, D-/L} = 1.0V; C_L = 0pF,$ | | | 1 | ms |
| t _{OFFAUDIO} | Turn-Off Time /SHDN to Output | 3.0 to 4.5 | $V_{D+/R, D-/L} = 1.0V; C_L = 0pF$ | | | 100 | μs |
| t _{MUTE_ON} | MUTE Turn-On Time | 3.0 to 4.5 | | | 1 | | μs |
| t _{MUTE_OFF} | MUTE Turn-Off Time | 3.0 to 4.5 | | | 1 | | μs |
| | | 2.7 | | | 25 | | |
| Pout | Output Power ⁽⁵⁾ | 3.3 | THD_N=1%, $V_{L,R}$ In Phase, RLOAD=32 Ω , 1KHz | | 35 | | mW _{rms} |
| | | 4.5 | | | 40 | | 1 |
| Vos | Output Offset Voltage | | Inputs Grounded | | 5 | | mV |
| Av | Amplifier Gain | | Input = -26dBV at 1kHz, R_L =16 Ω | | 0 | | dB |
| A _{MATCH} | Gain Matching of L & R Channels ⁽⁵⁾ | | Input = -26dBV, 20Hz to 20kHz | | | 0.5 | dB |
| f _R | Frequency Response ⁽⁵⁾ | | 20Hz to 20kHz referenced to 1kHz | -1.5 | | 1.5 | dB |
| THD+N | Distortion ⁽⁵⁾ | | f=1KHz, V_{sw} =50mVrms, R_L =64 Ω | | 0.1 | | % |
| SNR | Signal to Noise Ratio ⁽⁵⁾ | | A Weighted | | -90 | | dB |
| XTLK sprk | Crosstalk between L & R Channel ⁽⁵⁾ | | Input=-26bBV | | -60 | | dB |
| USB Switch | Path | | | | | | |
| t _{PDUSB} | USB Switch Propagation Delay ⁽⁵⁾ | 4.0 to 5.5 | $R_L = 50\Omega; C_L = 0pF$ | | 0.25 | | ns |
| t _{onusb} | Turn-On Time V _{BUS} to Output | 4.0 to 5.5 | $\label{eq:V_D+/R_D-/L} \begin{split} V_{D+/R_L} &= 1.0V; \ R_L = 32\Omega; \\ C_L &= 0pF, \ /SHDN, V_{CC} = 0 \end{split}$ | | | 5.5 | μs |
| t _{OFFUSB} | Turn-Off Time V _{BUS} to Output | 4.0 to 5.5 | $V_{D+/R, D-/L} = 1.0V; R_L = 32\Omega;$ $C_L = 0pF, /SHDN, V_{CC}=0$ | | | 2 | μs |
| BW | -3db Bandwidth – USB | 4.0 to 5.5 | $R_L=50\Omega$, $C_L=0pF$, Signal 0dBm | | 720 | | MHz |
| Power Supp | oly | | | | | | |
| t _{SUPPLY} | Power-Up Stabilization Time | | V+, V- within 90% of Final Value | | | 1 | ms |
| PSRR _{SPKR} | Power Supply Noise Rejection at Common Output ⁽⁵⁾ | | 217Hz 12% Duty Cycle Square Wave 2.7V to 3.2V at V_{CC} Output (D+/R) in V_{rms} as Single Wideband Noise Measurement within 20Hz – 20kHz, A Weighted | | -95 | | dB |

Note:

5. Guaranteed by characterization; not production tested.

USB High-Speed-Related AC Electrical Characteristics

 $T_A = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | $V_{BUS}(V)$ Conditions $T_A = -40^{\circ}C t$ | | 0°C to | +85°C | Unit | |
|--------------------|--|--|---|--------|-------|------|------|
| Symbol | Farameter | V _{BUS} (V) | Conditions | Min. | Тур. | Max. | Unit |
| t _{SK(P)} | Skew of Opposite Transitions of the Same Output ⁽⁶⁾ | 4.0 to 5.5 | t_{R} = t_{F} = 750ps (10-90%) at 240MHz C_{L} = 0pF, R_{L} = 50 Ω | | 35 | | ps |
| tj | Total Jitter ⁽⁶⁾ | 4.0 to 5.5 | R_L = 50Ω, C_L = 50pF, t_R = t_F = 500ps (10-90%) at 480Mbps (PRBS = 2 ¹⁵ - 1) | | 130 | | ps |

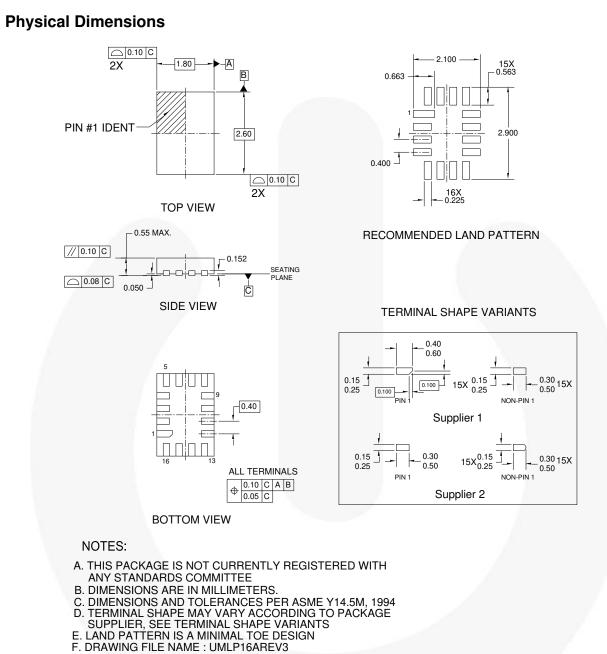
Note:

6. Guaranteed by characterization; not production tested.

Capacitance

 $T_A = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | | | $V_{CC}/V_{RUS}(V)$ Conditions $T_A = -40^{\circ}C$ to + | | | +85°C | Unit |
|-----------------|--|---------------------------------------|--|--|------|------|-------|------|
| Symbol | Farameter | V _{CC} /V _{BUS} (V) | Conditions | Min. | Тур. | Max. | Unit | |
| C _{IN} | Control Pin Input Capacitance (/SHDN, MUTE) | $V_{CC} = 3.0, 4.5$ | $V_{\text{Bias}} = 0.05 V$ | | 2.8 | | pF | |
| C_{ON_USB} | D+, D- (Source Port) On Capacitance | $V_{BUS}=5.0$ | $V_{Bias} = 0.2V$, f = 1MHz, f=240MHz | | 8.8 | | рF | |
| C_{OFF_USB} | D+, D- (Source Port) Off Capacitance | $V_{BUS}=5.0$ | f = 1MHz | | 2.8 | | pF | |





| Order Number | Operating Temperature Range | Package Description | Packing Method |
|--------------|-----------------------------|--|----------------|
| FSA2000UMX | -40 to 85°C | 16-Terminal Ultrathin Molded Leadless Package (UMLP) | Tape & Reel |

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FSA2000 – Auto-Selecting HS-USB Switch with Cap-Free Headphone Audio Amplifier

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Rev. 148

FSA2000 – Auto-Selecting HS-USB Switch with Cap-Free Headphone Audio Amplifier

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